


Relative Orientations

- ① Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- ② Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).
- ④ Leads: material- BeCu Alloy 194; plating- 60/40 SnPb (150-400µ")
- ⑤ Test points: material- Phosphor Bronze; plating- Sn over 50µ" Ni. Gold flash on contact end.

Description: Package Converter
 28 position DIP socket with test points to 28 position PLCC j-leaded SMT foot.

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

PC-DIP/PLCC28-J-T-02 Drawing		Status: Released	Scale 2:1	Rev:B
 <p>© 1996 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com</p>	Drawing: V. Thao		Date: 7/10/96	
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